Model	UF3000Exe
OCR:	Yes
Wafer specification	Size: 8"/12"
	Thickness: 240~2200um
	Die size: 350~76000um
Autoloader unit	300 mm FOUP/ FOSB and 200 mm cassette
	Single port Loader
Interface	GPIB
Chuck	Nickel plate
	Planarity : 15um (20℃≦t ≦50℃)
	30um (50℃≦t ≦200℃)
	Temperature : 30℃ to 150℃
	Withstand Load : 200kgf
Display Unit:	15" color display & touch panel
Cleaning Unit	(100 mm x 60mm) 3 block with vacuum type
APC function	No
Miscellaneous	1. Touch sensor. 2. Ethernet interface. 3. Cognex 8200
Docking interface	VLCT/J750 combo
Auto hinge	No
Probe card holder	No
Touch sensor	Yes